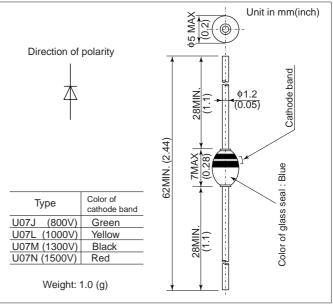


FEATURES

- For high speed switching.
- Diffused-junction. Glass passivated and encapsulated.

OUTLINE DRAWING



ABSOLUTE MAXIMUM RATINGS

| ltems | Туре | | U07J | U07L | U07M | U07N | | |
|---------------------------------------|--------------------|------------------|--|------|------|------|--|--|
| Repetitive Peak Reverse Voltage | V_{RRM} | V | 800 | 1000 | 1300 | 1500 | | |
| Non-Repetitive Peak Reverse Voltage | V _{RSM} | V | 1000 | 1300 | 1600 | 1800 | | |
| Average Forward Current | I _{F(AV)} | А | 1.0 (Single-phase half sine wave 180° conduction TL = 60°C, Lead length = 10mm) | | | | | |
| Surge(Non-Repetitive) Forward Current | I _{FSM} | А | 50(Without PIV, 10ms conduction, Tj = $140^{\circ}C$ start) | | | | | |
| I ² t Limit Value | l ² t | A ² s | 10(Time = 2 ~ 10ms, I = RMS value) | | | | | |
| Operating Junction Temperature | Tj | °C | -65 ~ +140 | | | | | |
| Storage Temperature | T _{stg} | °C | -65 ~ +200 | | | | | |

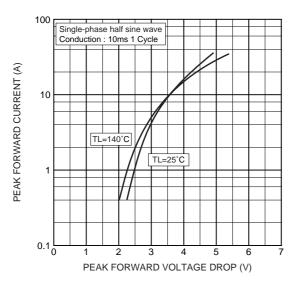
Notes (1) Lead mounting : Lead temperature 300°C max. to 3.2mm from body for 5sec. max.. (2) Mechanical strength : Bending 90°×2 cycles or 180°×1 cycle, Tensile 3kg, Twist 90°×1 cycle.

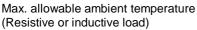
CHARACTERISTICS(T_L=25°C)

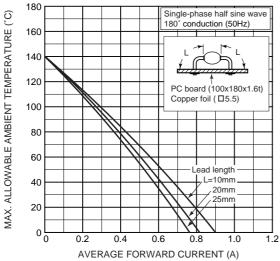
| Items | Symbols | Units | Min. | Тур. | Max. | Test Conditions |
|--------------------------------|--|-------|------|------|----------|---|
| Peak Reverse Current | I _{RRM} | μA | _ | 2.0 | 10 | Rated V _{RRM} |
| Peak Forward Voltage | V _{FM} | V | _ | _ | 2.5 | I_{FM} =1.0 Ap, Single-phase half sine wave 1 cycle |
| Reverse Recovery Time | trr | μs | _ | _ | 0.4 | I _F =2mA, V _R =-15V |
| Steady State Thermal Impedance | R _{th(j-a)} R _{th(j-l)} | °C/W | _ | _ | 60 30 | Lead length = 10 mm |

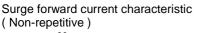
U07

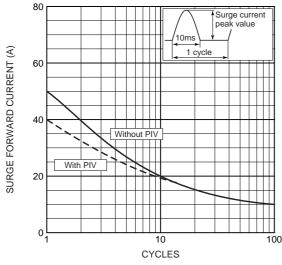
Forward characteristics



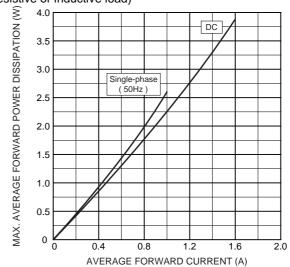




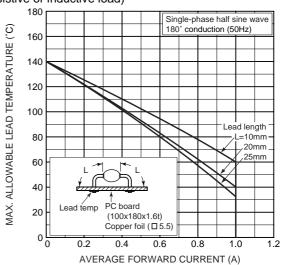




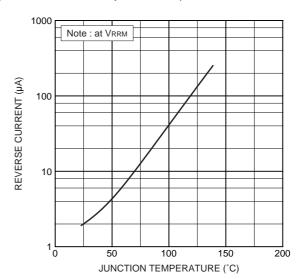
Max. average forward power dissipation (Resistive or inductive load)



Max. allowable lead temperature (Resistive or inductive load)



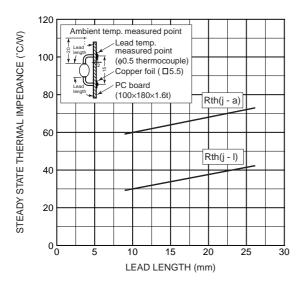
Typ. reverse current vs. junction temperature



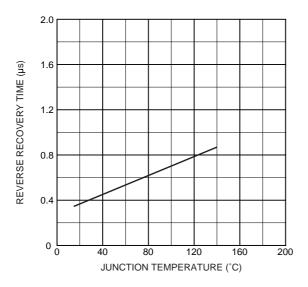
HITACHI

U07

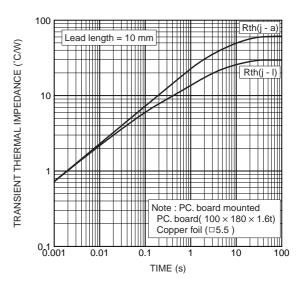
Steady state thermal impedance



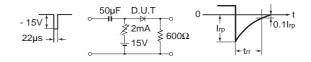
Typ. reverse recovery time vs. junction temperature



Transient thermal impedance



Reverse recovery time(trr) test circuit



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HITACHI POWER SEMICONDUCTORS

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